

Predicting Thermal Properties From Microstructures

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Spray Coatings-Thermal Barrier Coatings
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NIST

National Institute of
Standards and Technology

Collaborators & Acknowledgments

- ❖ Stephen A. Langer, Information Tech. Lab, NIST
- ❖ Andrew C. E. Reid & Andrew R. Roosen, MSEL, NIST
- ❖ Marion Bartsch and Uwe Schulz, Deutsches Zentrum für Luft- und Raumfahrt (DLR), Germany
- ❖ Jean Marc Dorvaux, Rémy Mevrel, and Odile Lavigne, ONERA, France
- ❖ Yougen Yang, Derek Hass, & Haydn N. G. Wadley, Univ. of Virginia
- ❖ James Ruud, N. S. Hari, James Grande, and Antonio Mogro-Campero, GE Corporate R & D Center

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Motivation: to predict thermal conductivity, k , of TBC's from microstructure

Laser flash measurements are time consuming, expensive, and require special expertise. Accordingly, such measurements are:

- *rarely made during materials development*
- *used sparingly by turbine part designers*
- *typically not included in production qualification & QC*

Benefits of inexpensive, widely available, rapid predictor

- *More accurate cooling and lifing of gas turbine parts*
- *Optimization of k during TBC material development*
- *Design of lower k TBC materials on computer*
- *Spray vendors qualify TBC's for thermal conductivity*

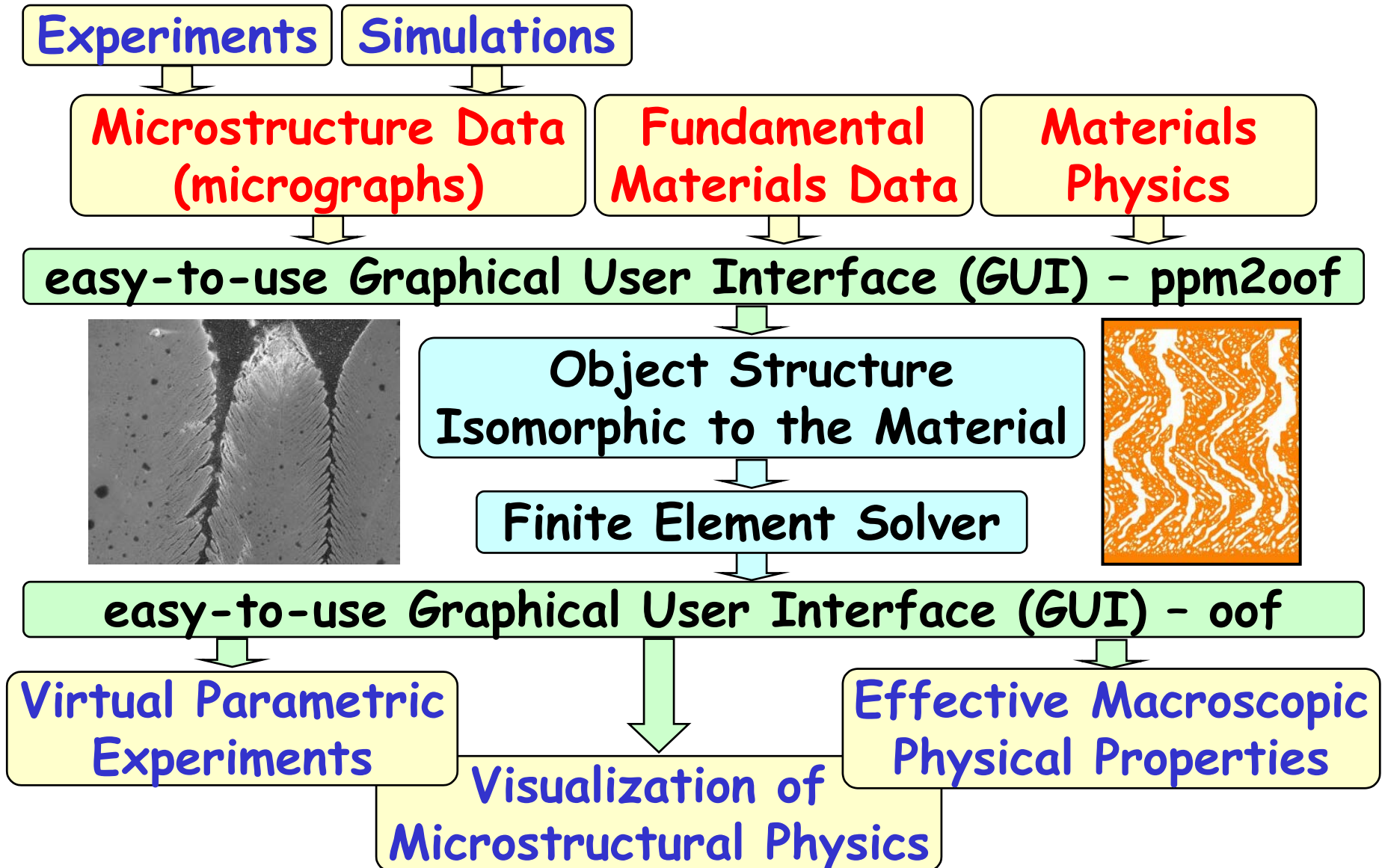
Predicting Thermal Properties From Microstructures

TECHNICAL APPROACH: Develop computational tools for simulating properties and elucidating influences of stochastic, anisotropic microstructural features (e.g., porosity) on physical properties

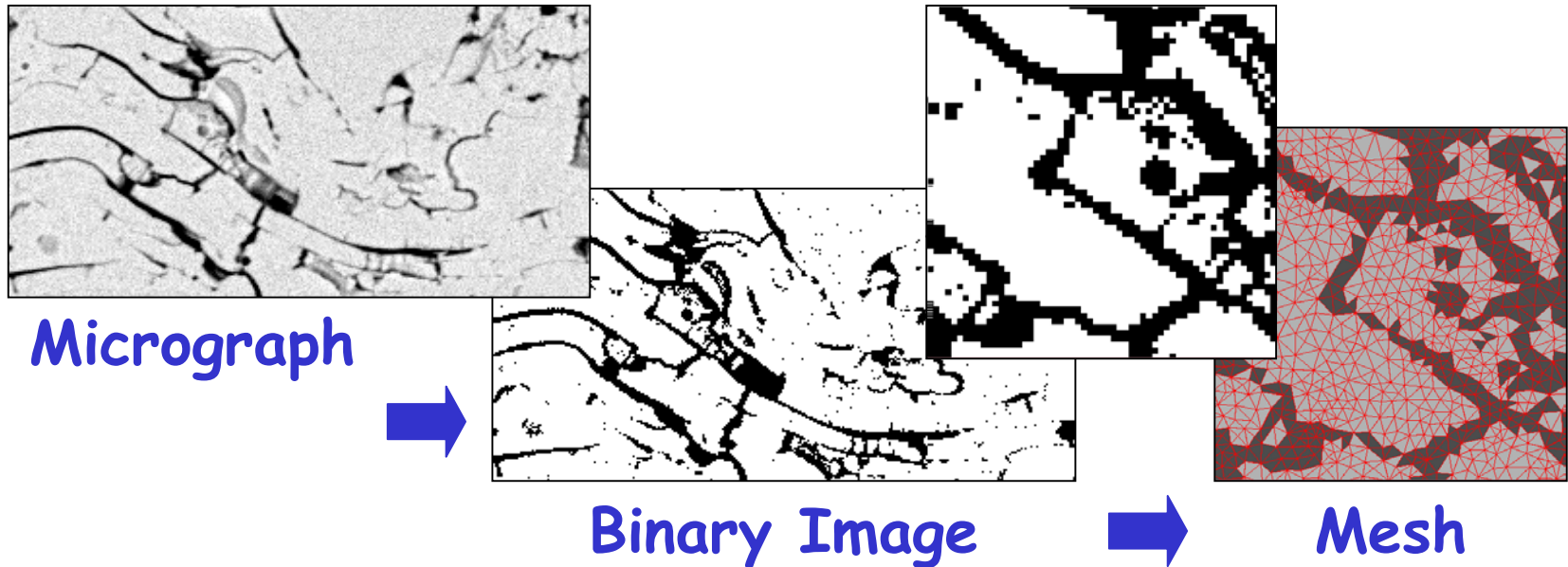
CONTENTS:

- Microstructural simulation approach (OOF)
- Thermal Conductivity simulations
 - ❖ EB-PVD TBCs
 - ❖ EB-DVD TBCs
 - ❖ Thermal Spray TBCs

Building a Microstructural Model

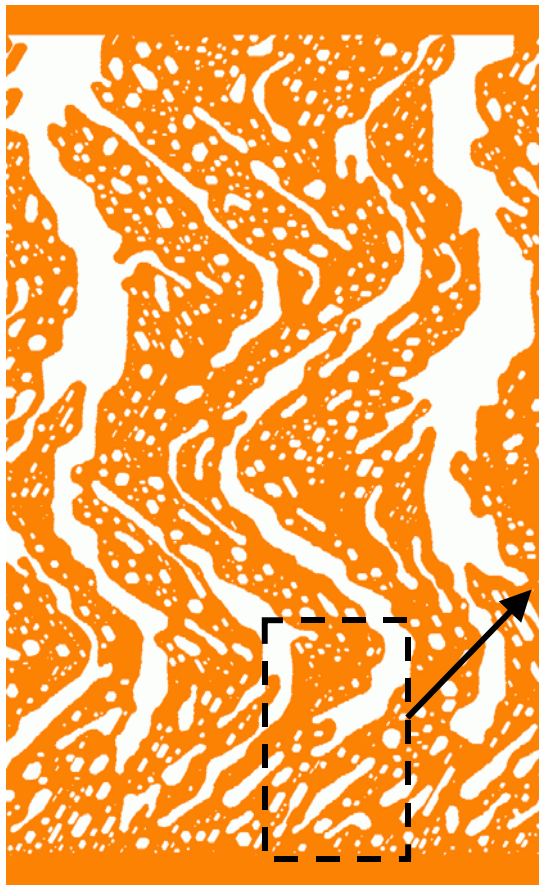


PPM2OOF Tool

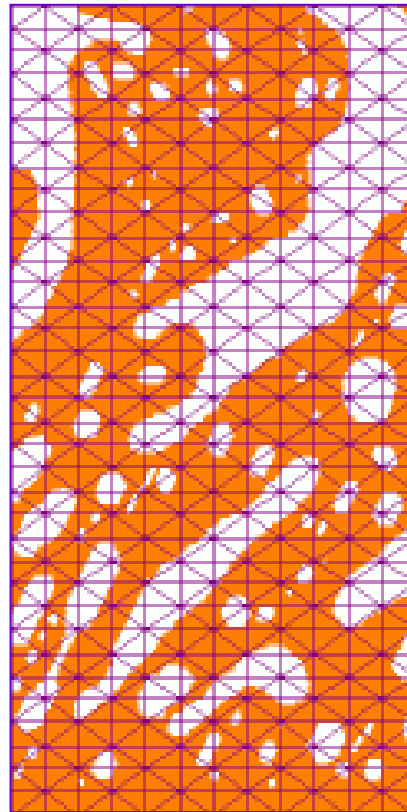


- Convert micrograph to “.ppm” (portable pixel map) file
- Select & identify phases to create binary image
- Assign constitutive physical properties to each phase
- Mesh in PPM2OOF via “Simple Mesh” or “Adaptive Mesh” - multiple algorithms that allow elements to adapt to the microstructure

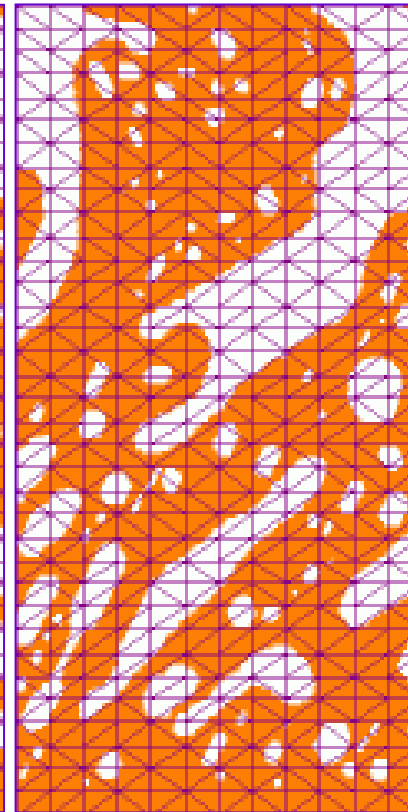
Adaptive Meshing by Components: refine elements and move nodes via Monte Carlo annealing to reduce $E = (1-\alpha)E_{shape} + \alpha E_{homogeneity}$



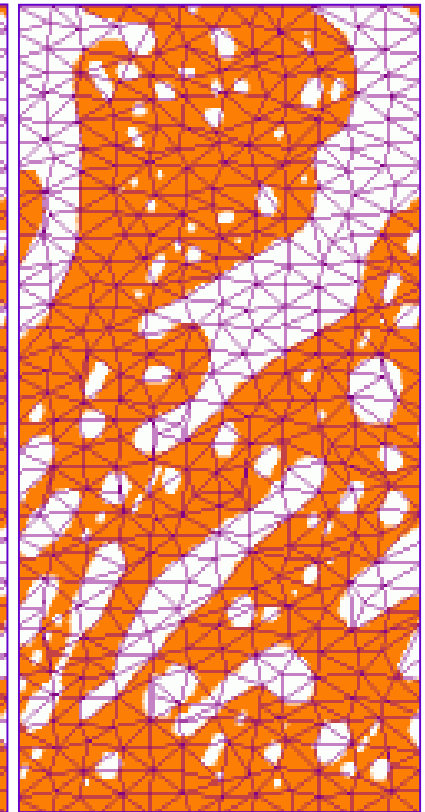
image



create
mesh



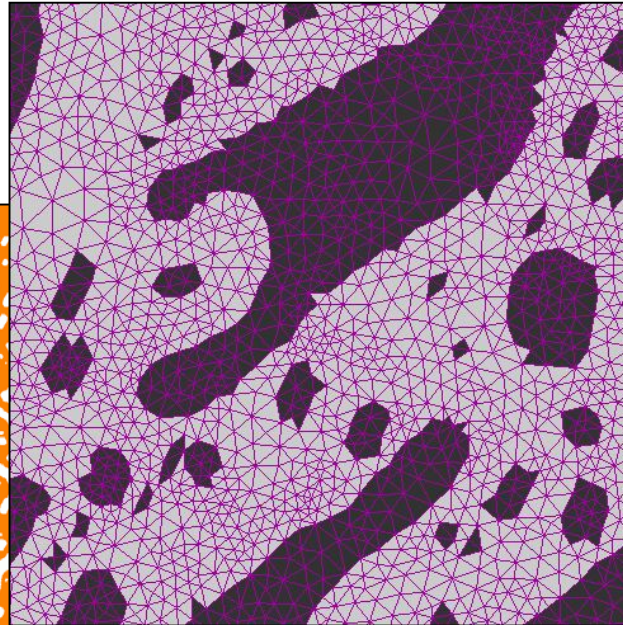
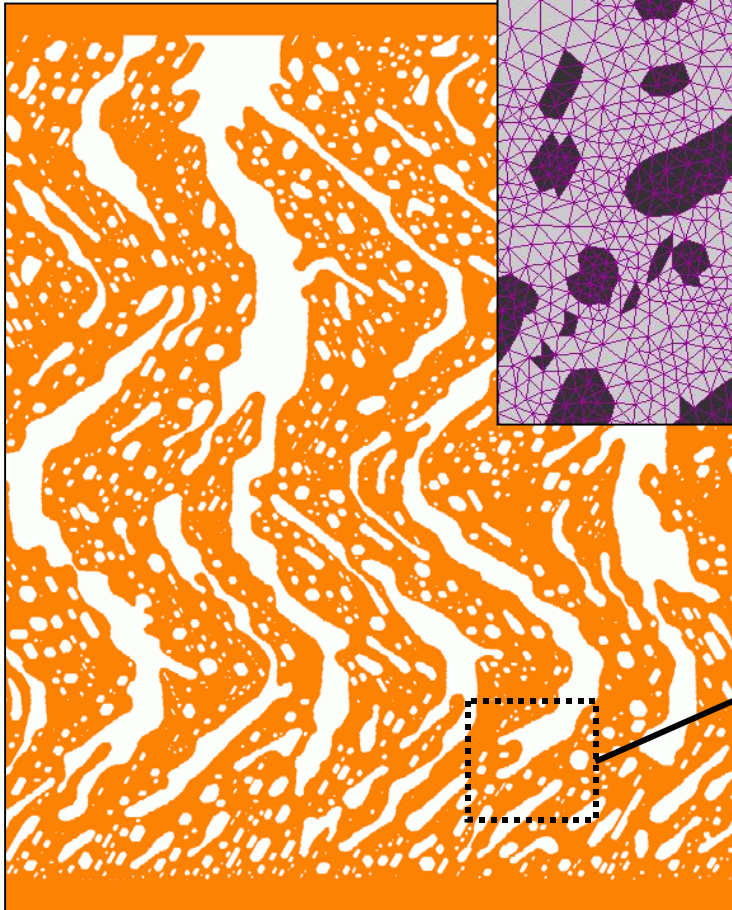
swap worst
to reduce E



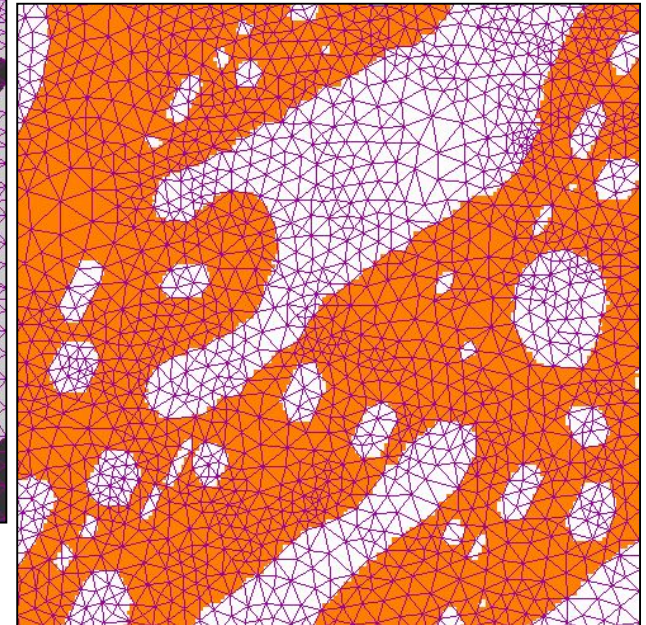
anneal to
reduce E

Adaptive Meshing by Components

pixel
image



mesh



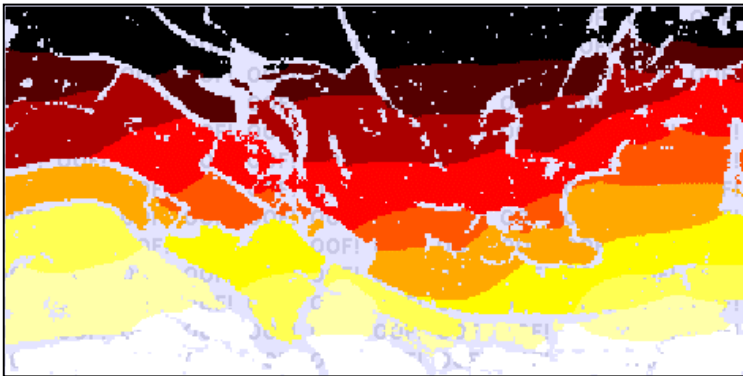
pixel image
with mesh

Generate a finite-element mesh
following the material boundaries

OOF Tool

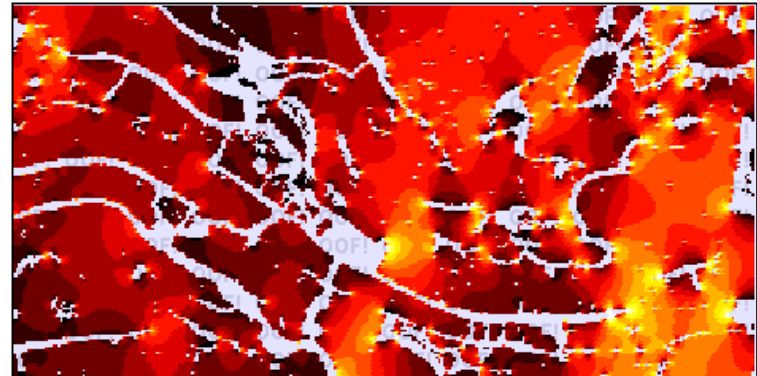
Virtual Experiments:
Temperature Gradient

$T_0 + \delta T$



$T_0 - \delta T$

Visualize & Quantify:
Heat Flux Distribution



Perform virtual experiments on finite-element mesh:

- To determine effective macroscopic properties
- To elucidate parametric influences
- To visualize microstructural physics



2.0

Current Development Effort

Stephen A. Langer & Andrew C. E. Reid

- **Extensible and more flexible platform**
- Enhanced image analysis tools
- Expanded element types
- **Generalized constitutive relations** (elasticity, piezoelectricity, etc.) w/coupling between fields

$$\text{Equil. Eq.: } \nabla \cdot \Psi = f$$

$$\text{Constitutive Eq.: } \Psi = c \cdot \nabla \phi$$

- **Linear and nonlinear solvers**
with automatic mesh refinement

Planned Additions

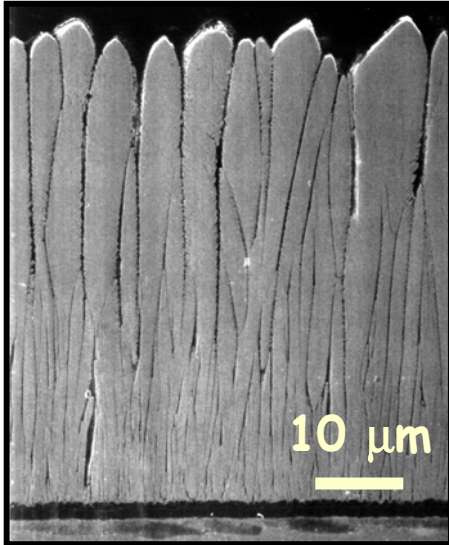
- 3-dimensional finite element solver
- Time-dependent solver
- Plasticity

Predicting Thermal Properties From Microstructures

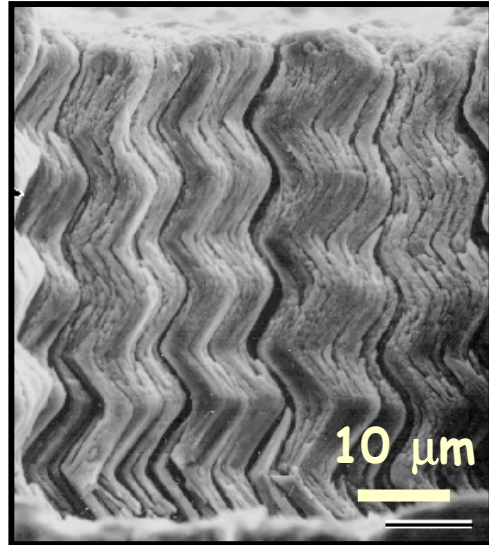
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 - ❖ EB-DVD TBCs
 - ❖ Thermal Spray TBCs

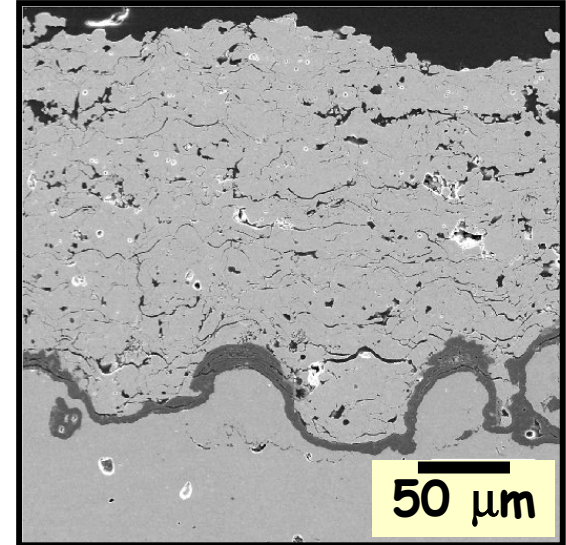
Types of Thermal Barrier Coatings and Deposition Processes



EB-PVD TBC's



EB-DVD TBC's



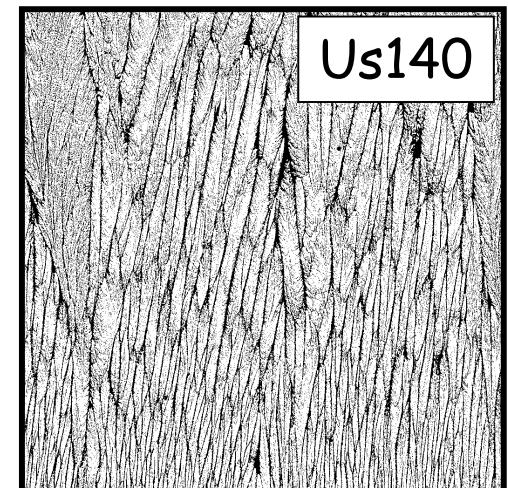
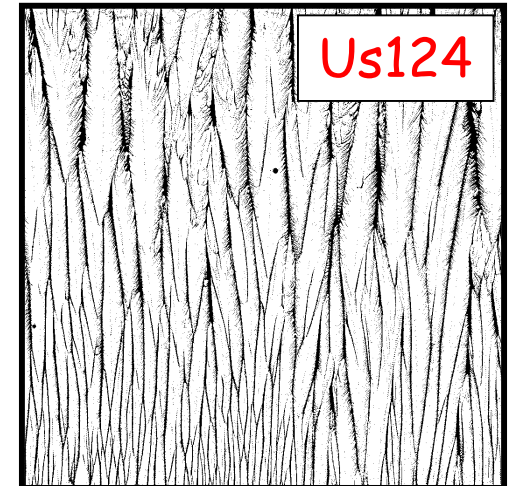
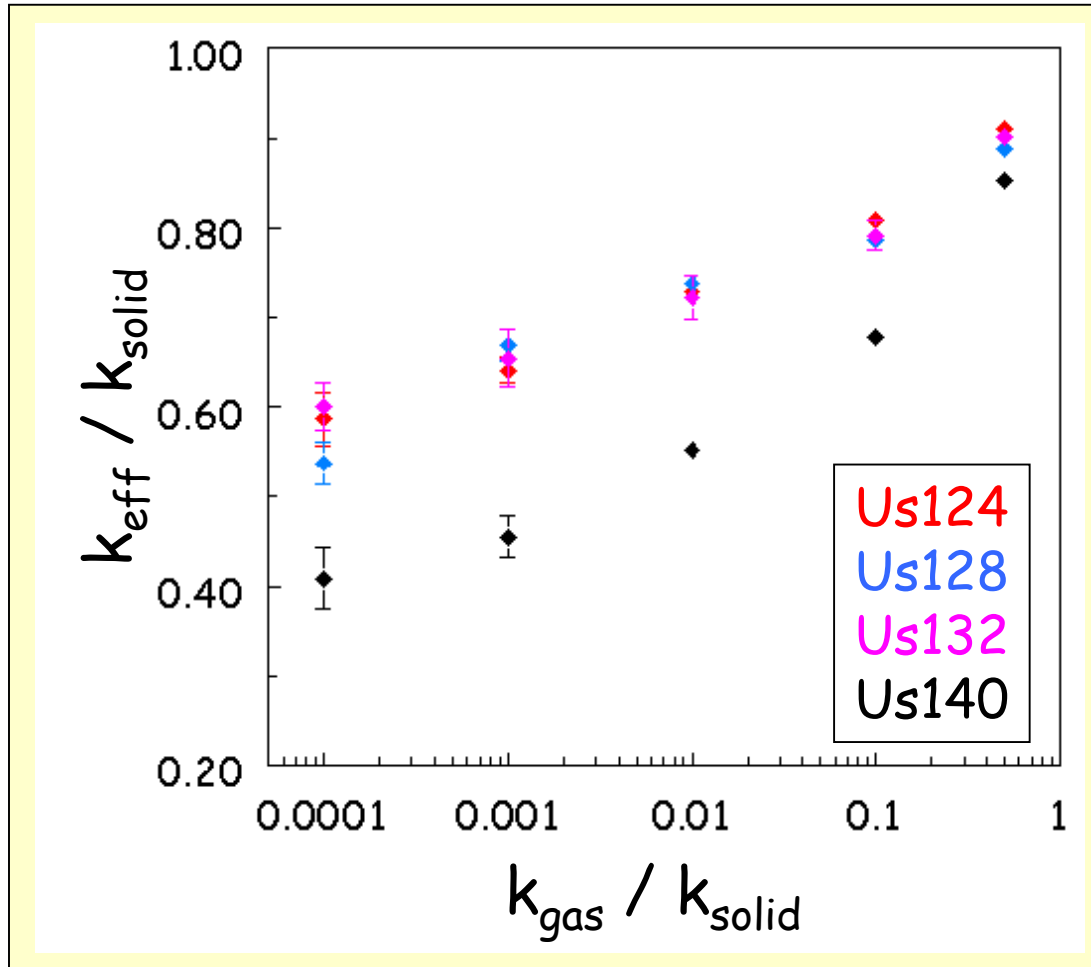
APS TBC's

Selected Deposition Processes

for the yttria stabilized zirconia (YSZ) ceramic top coat

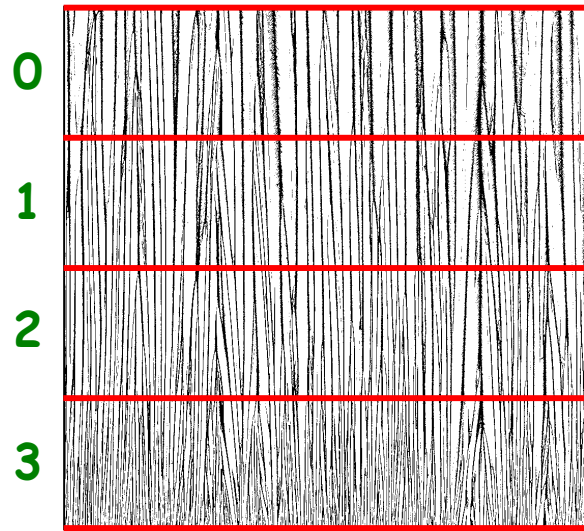
- electron-beam physical vapor deposition (EB-PVD)
- electron-beam directed vapor deposition (EB-DVD)
- thermal spray (TS) or air plasma spray (APS)

Thermal Conductivity of EB-PVD TBC's

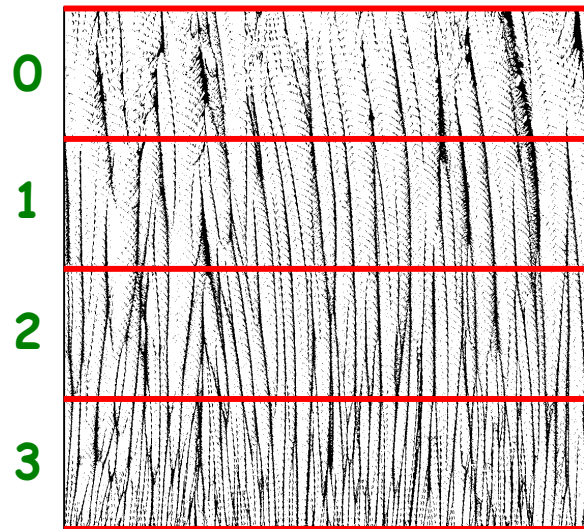
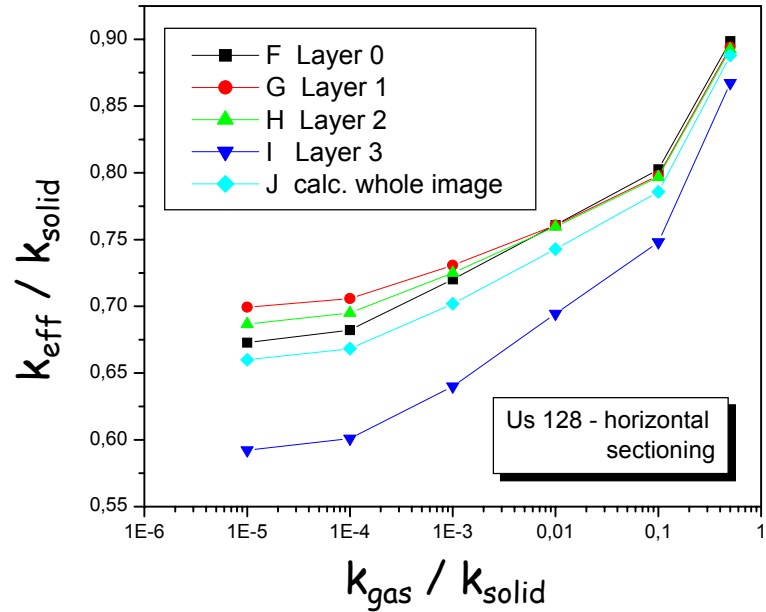


Marion Bartsch & Uwe Schulz, DLR, Germany;
Jean Marc Dorvaux, Rémy Mevrel, & Odile Lavigne, ONERA, France

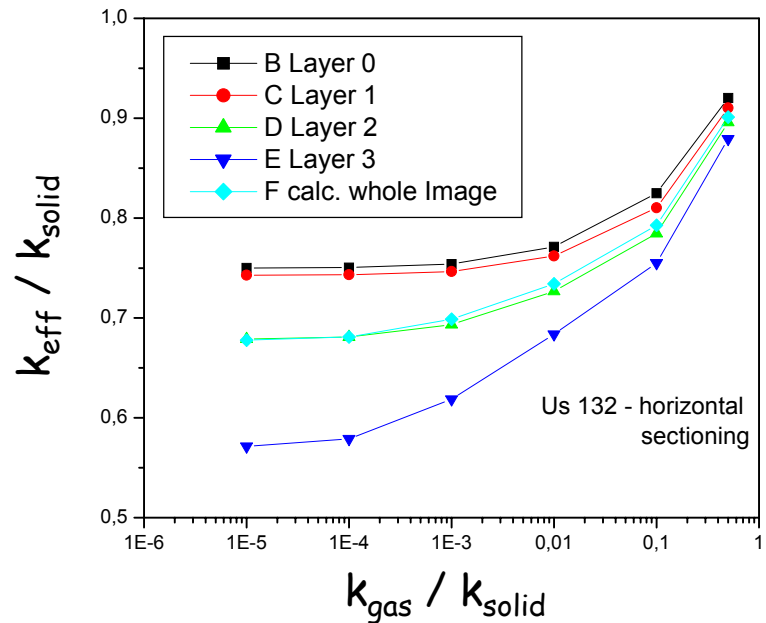
Variation with Deposition Layer



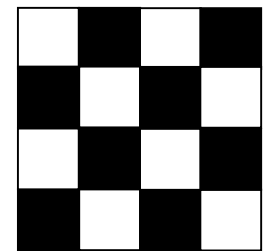
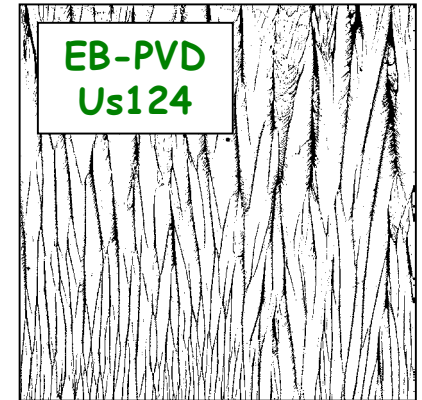
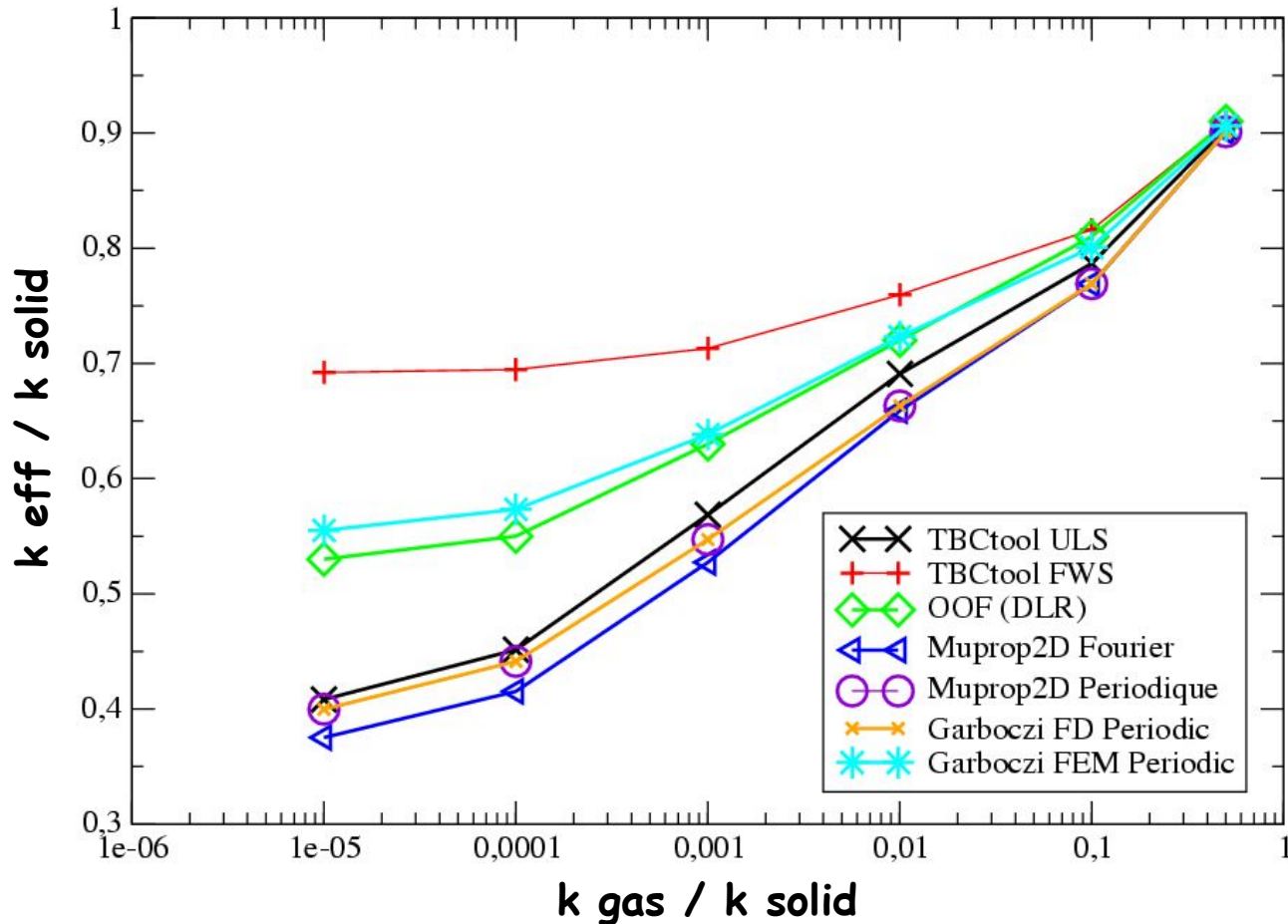
EB-PVD
Us128



EB-PVD
Us132

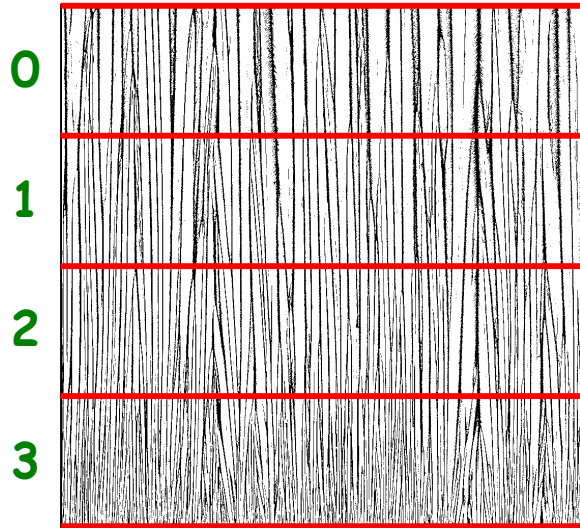


Comparison of Computational Tools and Simulation Boundary Conditions

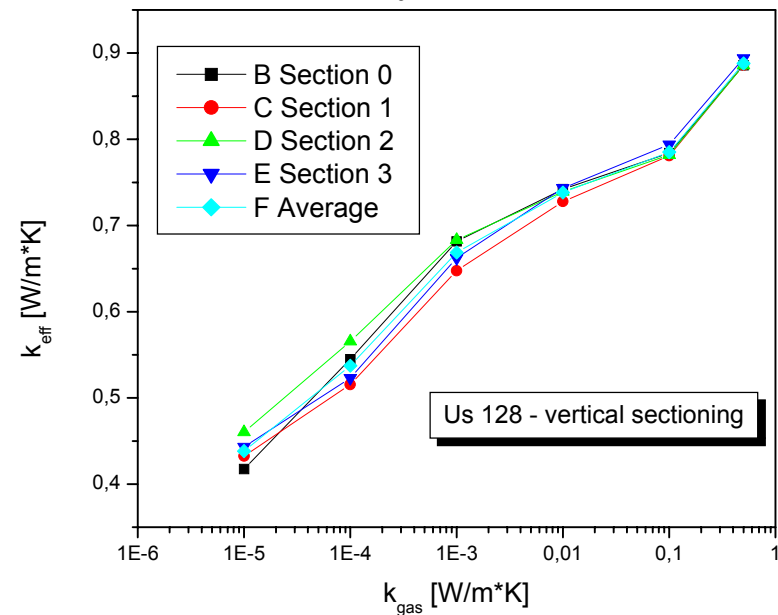
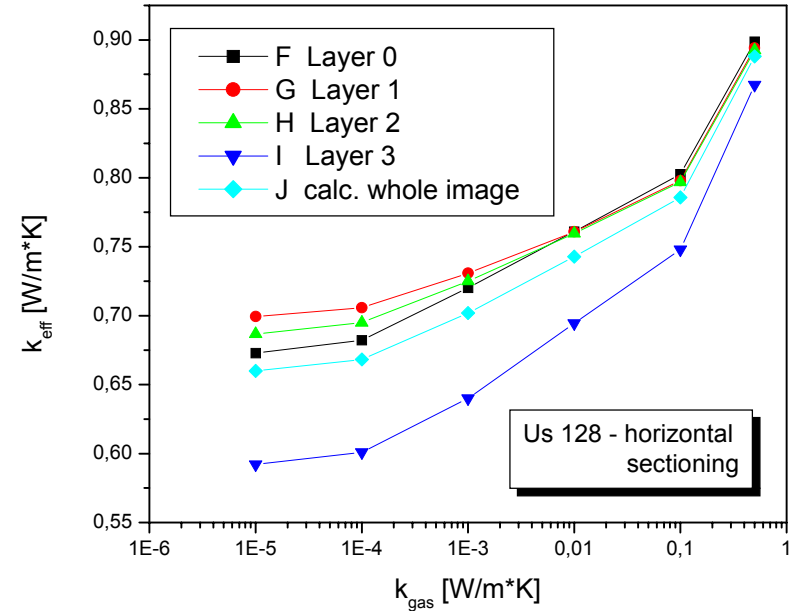
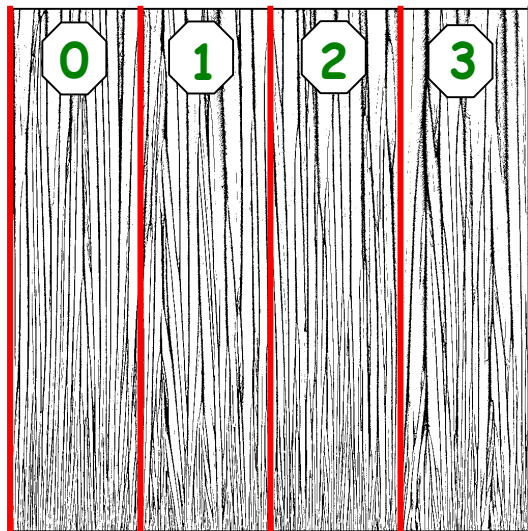


Jean Marc Dorvaux & Rémy Mevrel, ONERA, France
 Marion Bartsch & Uwe Schulz, DLR, Germany

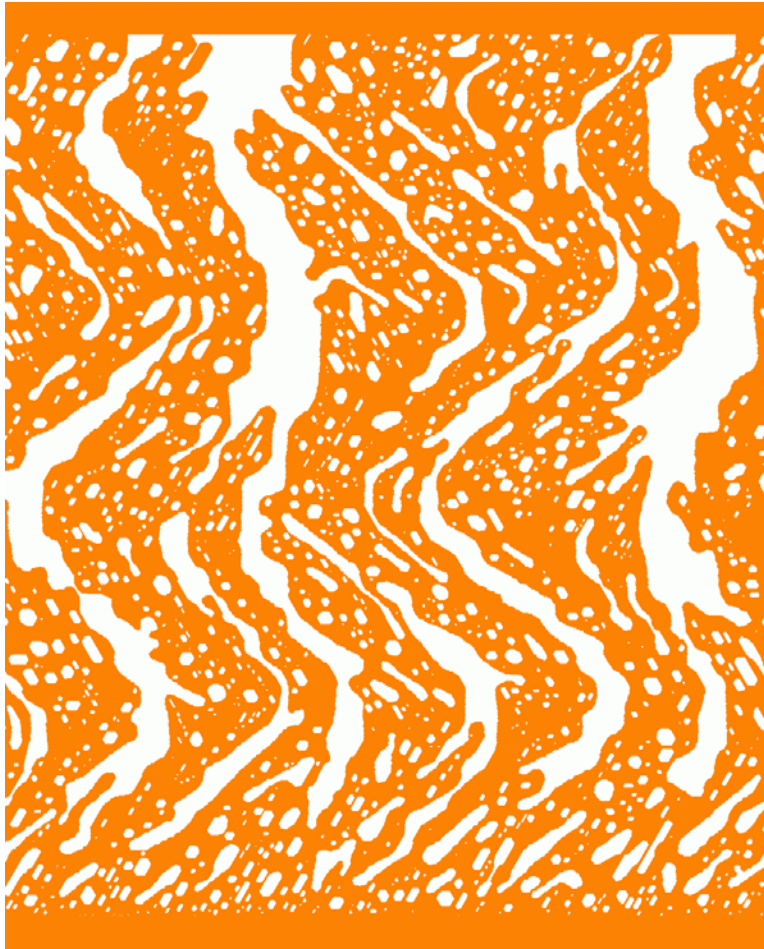
Percolation Influence on Properties



EB-PVD - Us128



Optimization of Low Conductivity EB-DVD Microstructures

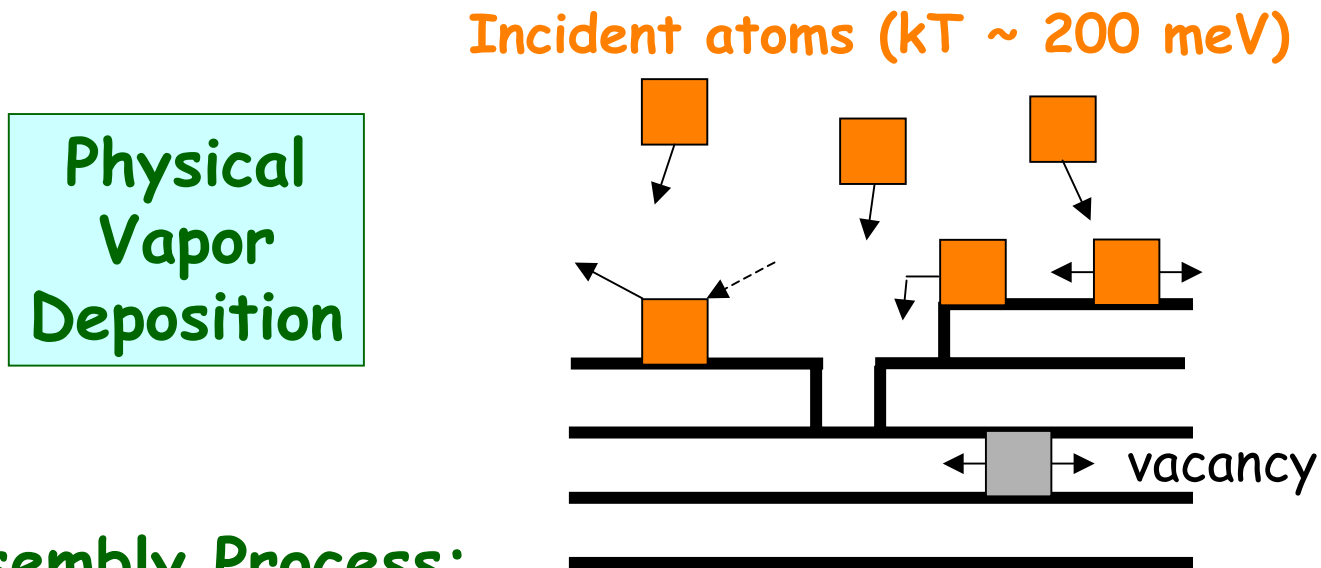


Electron-Beam Directed
Vapor Deposition coating
microstructure via kinetic
Monte Carlo simulation

- Deposition at
 $T/T_m = 0.23$
- Annealed at
 $T/T_m = 0.43$

substrate was periodically
inclined to the vapor flux

Kinetic Monte Carlo Simulation of Atomic Condensation

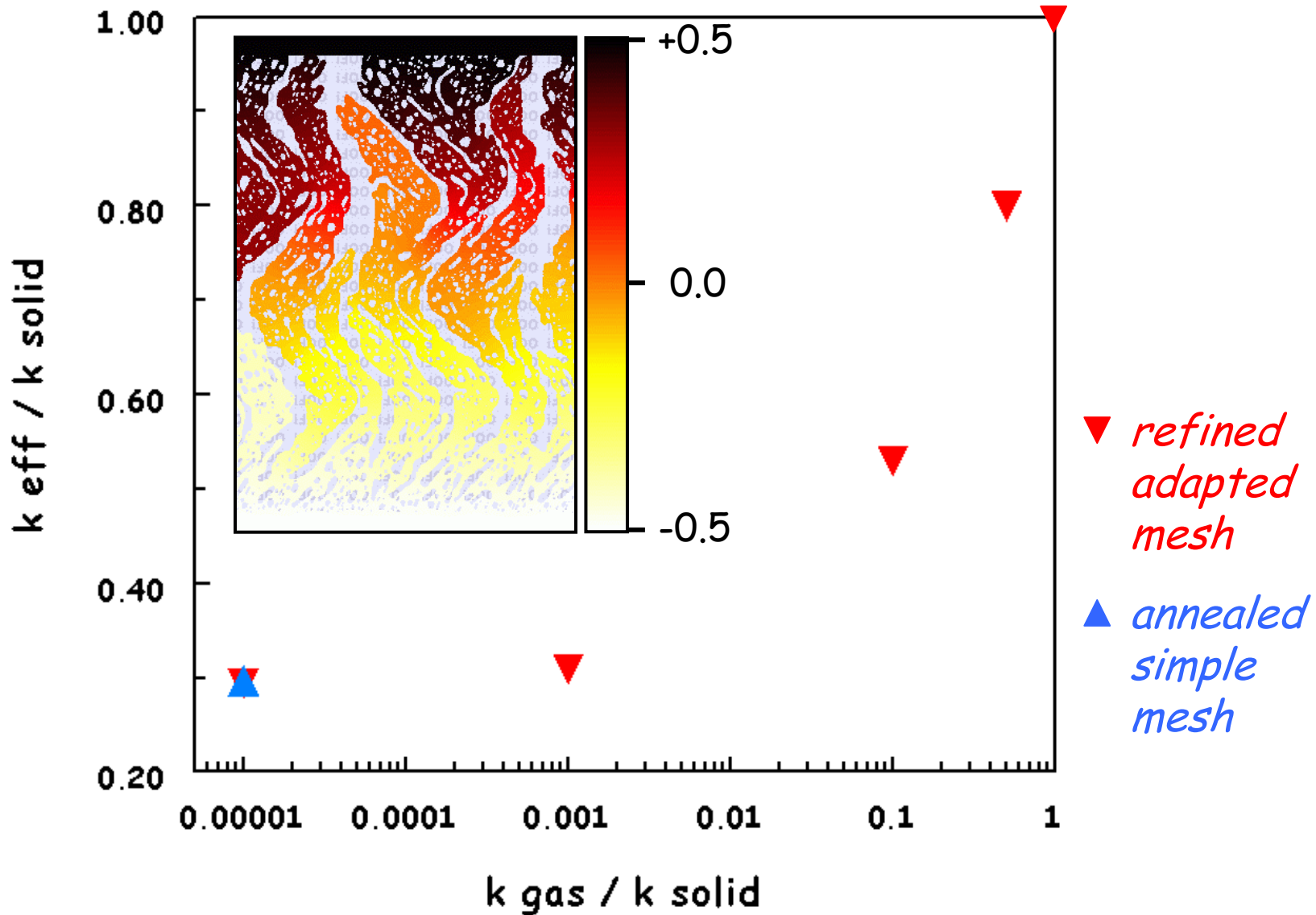


Assembly Process:

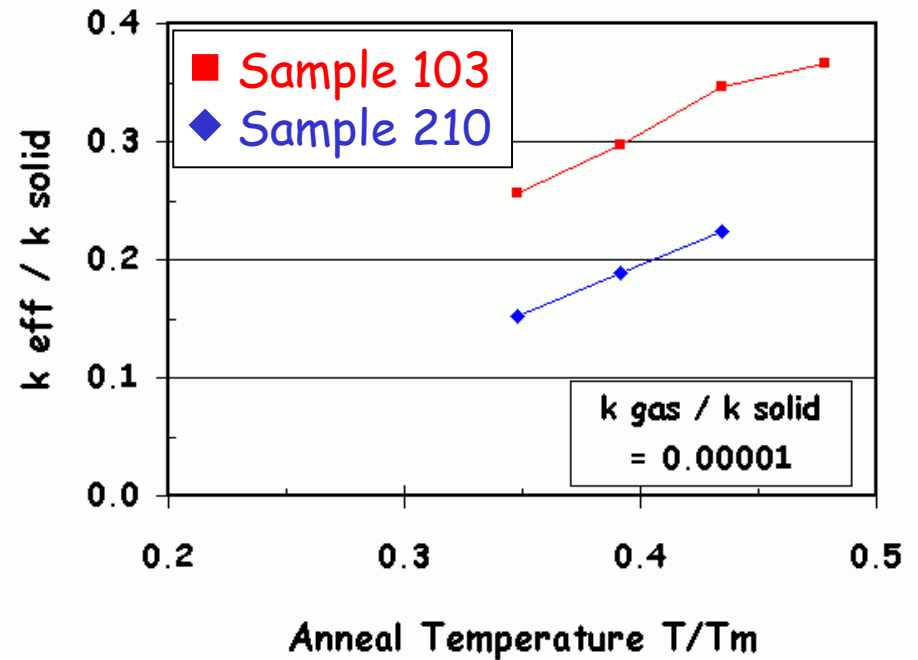
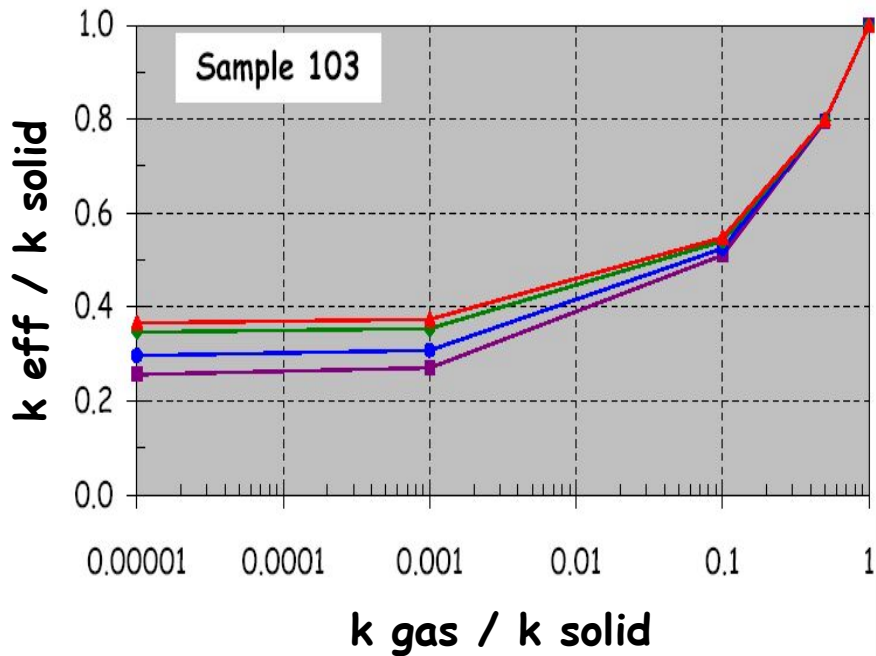
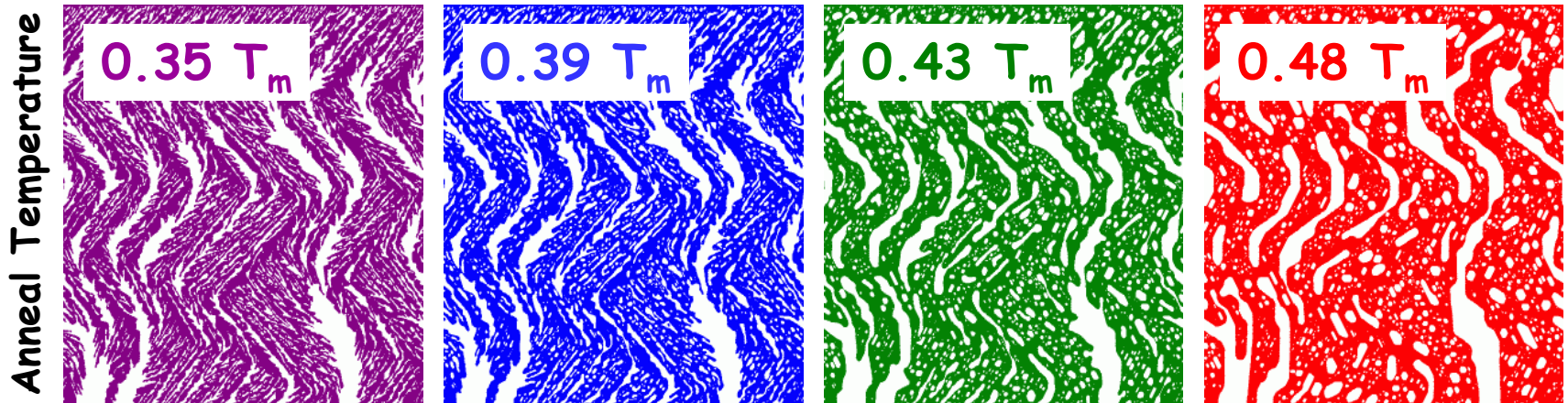
- Condensation
- Thermal diffusion (surface, bulk)
- Incident atom-growing surface interactions, including reflection, resputtering, etc.

kinetic Monte Carlo (kMC) for diffusion
Molecular Dynamics (MD) for effects of energy

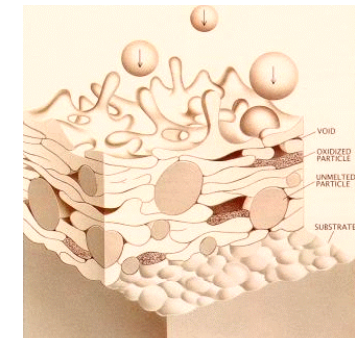
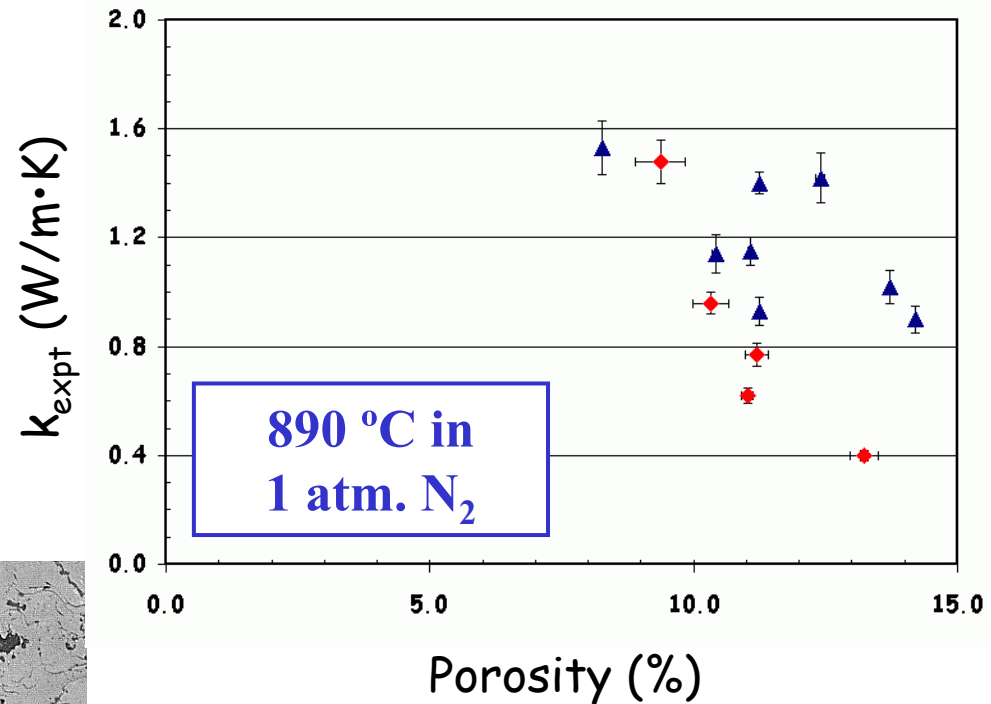
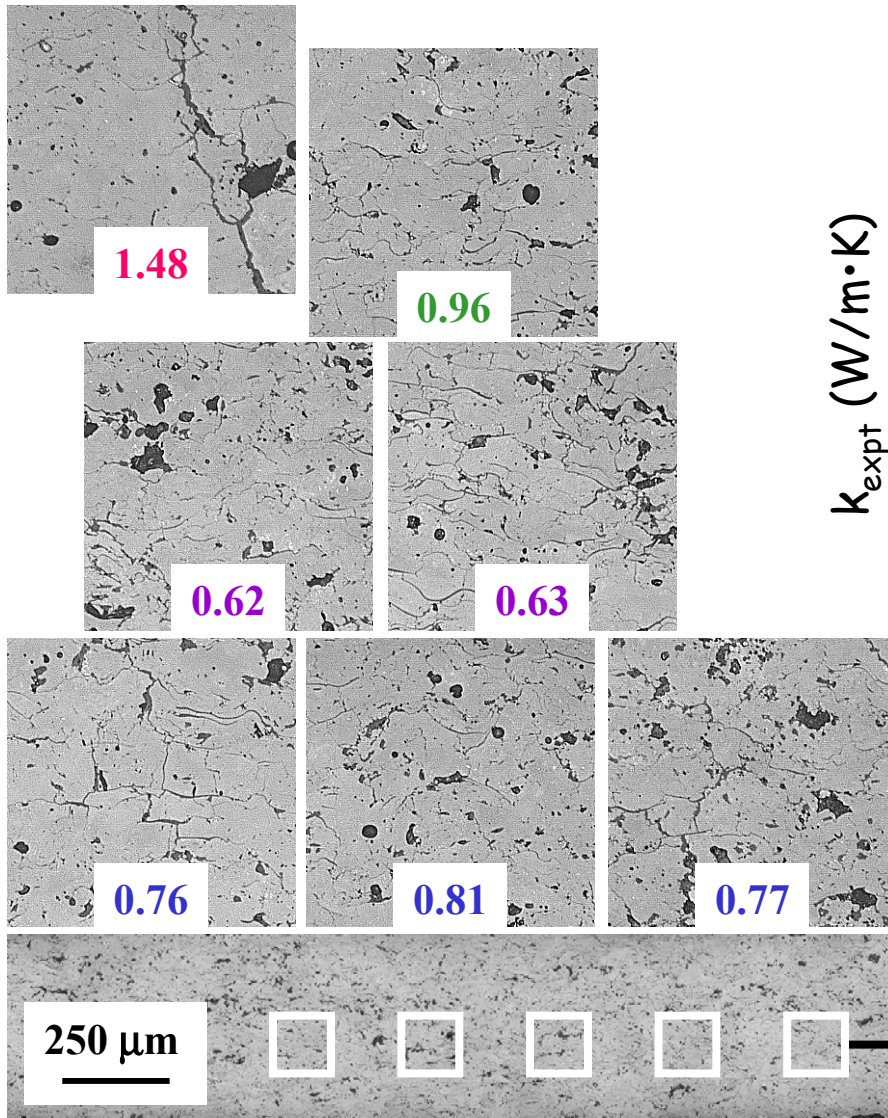
Effective Thermal Conductivity



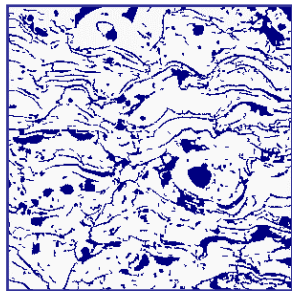
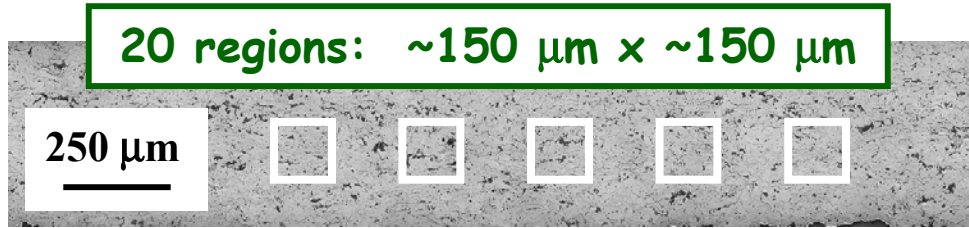
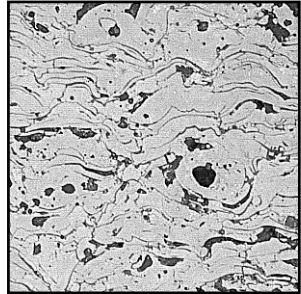
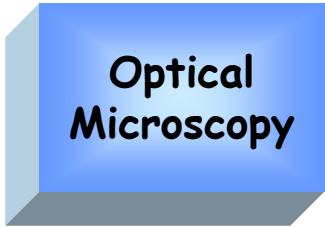
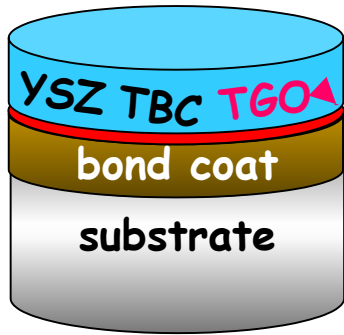
Thermal Conductivity Simulations



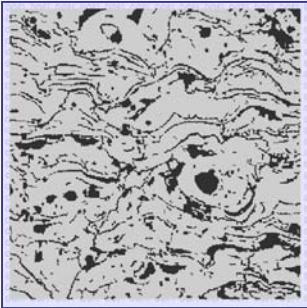
TBC Thermal Conductivity Measurements



Thermal Conductivity via OOF Simulations

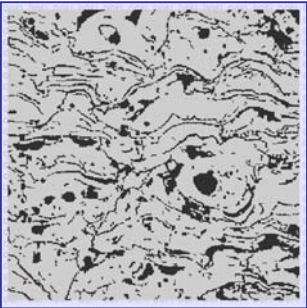


Virtual experiment
 $T + 0.5^\circ\text{C}$



$T - 0.5^\circ\text{C}$

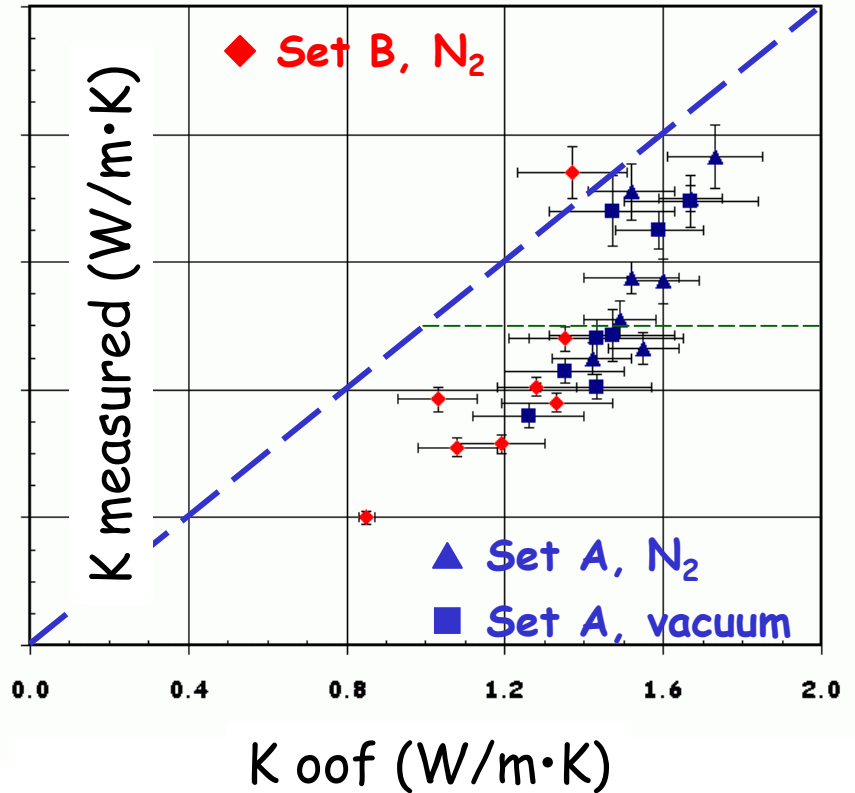
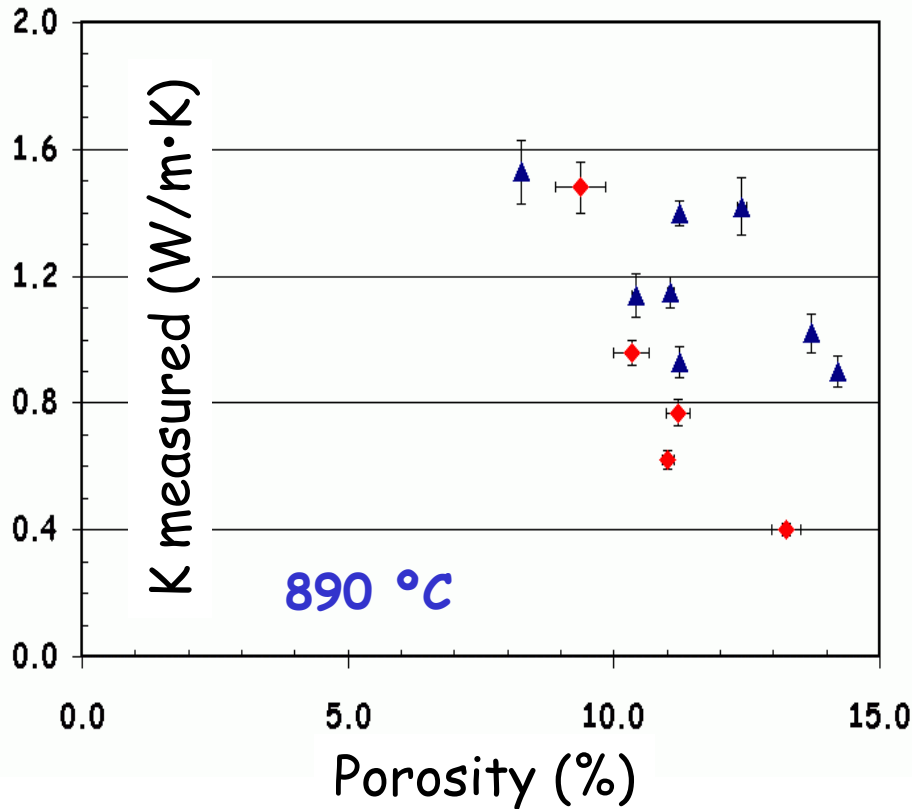
finite-element
mesh



segmented
image



Results for Two Sets of TBC Microstructures



- *Consistent correlation for wide range of microstructures*
- *Data below $\sim 1\text{ W/m}\cdot\text{K}$, slope of ≈ 1 , but high absolute value*
- *Data above $\sim 1\text{ W/m}\cdot\text{K}$, slope of < 1 ; (vertically cracked)*

Influences of Image Resolution

Calculated
 K_{bulk} :

1.076
 $\text{W}/\text{m}\cdot\text{K}$

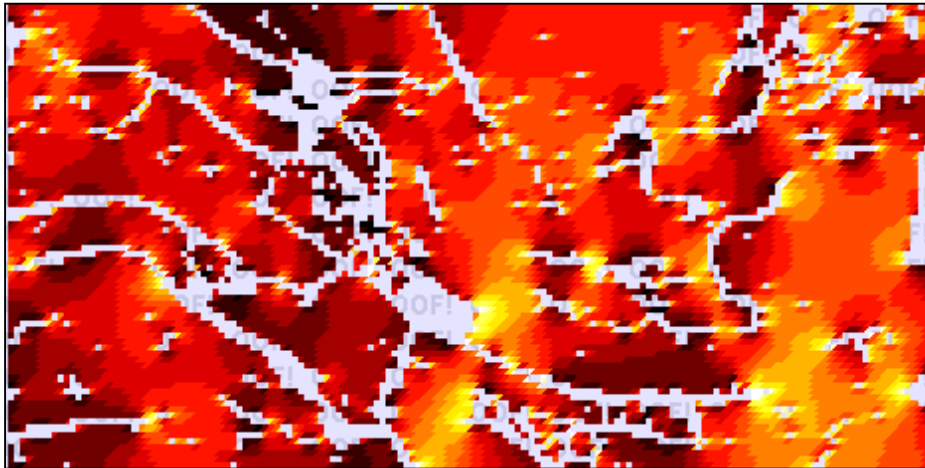
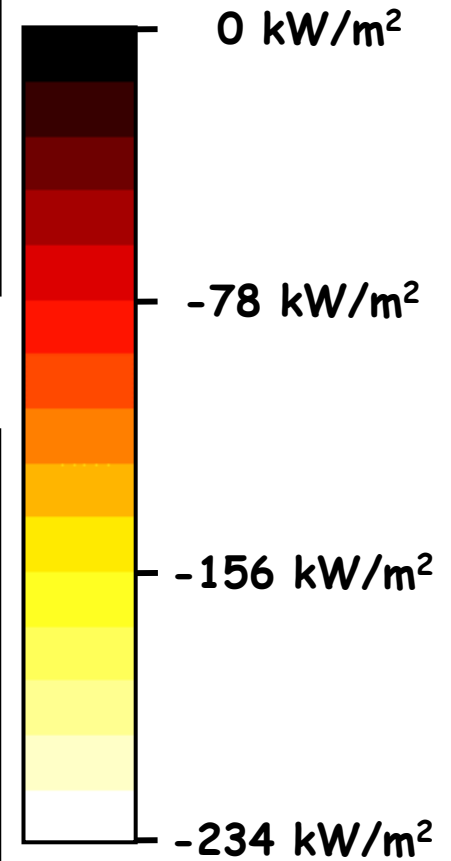


Image Resolution: $0.428 \mu\text{m}/\text{pixel}$

Heat Flux
Distribution



0.940
 $\text{W}/\text{m}\cdot\text{K}$

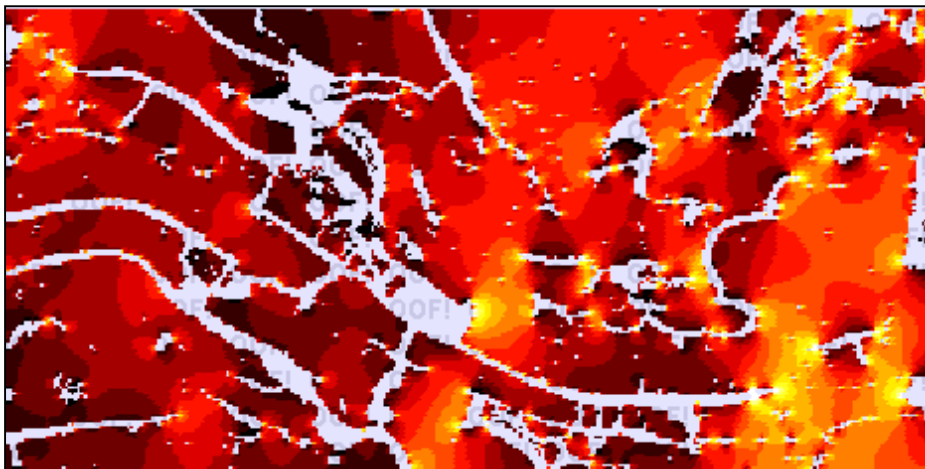
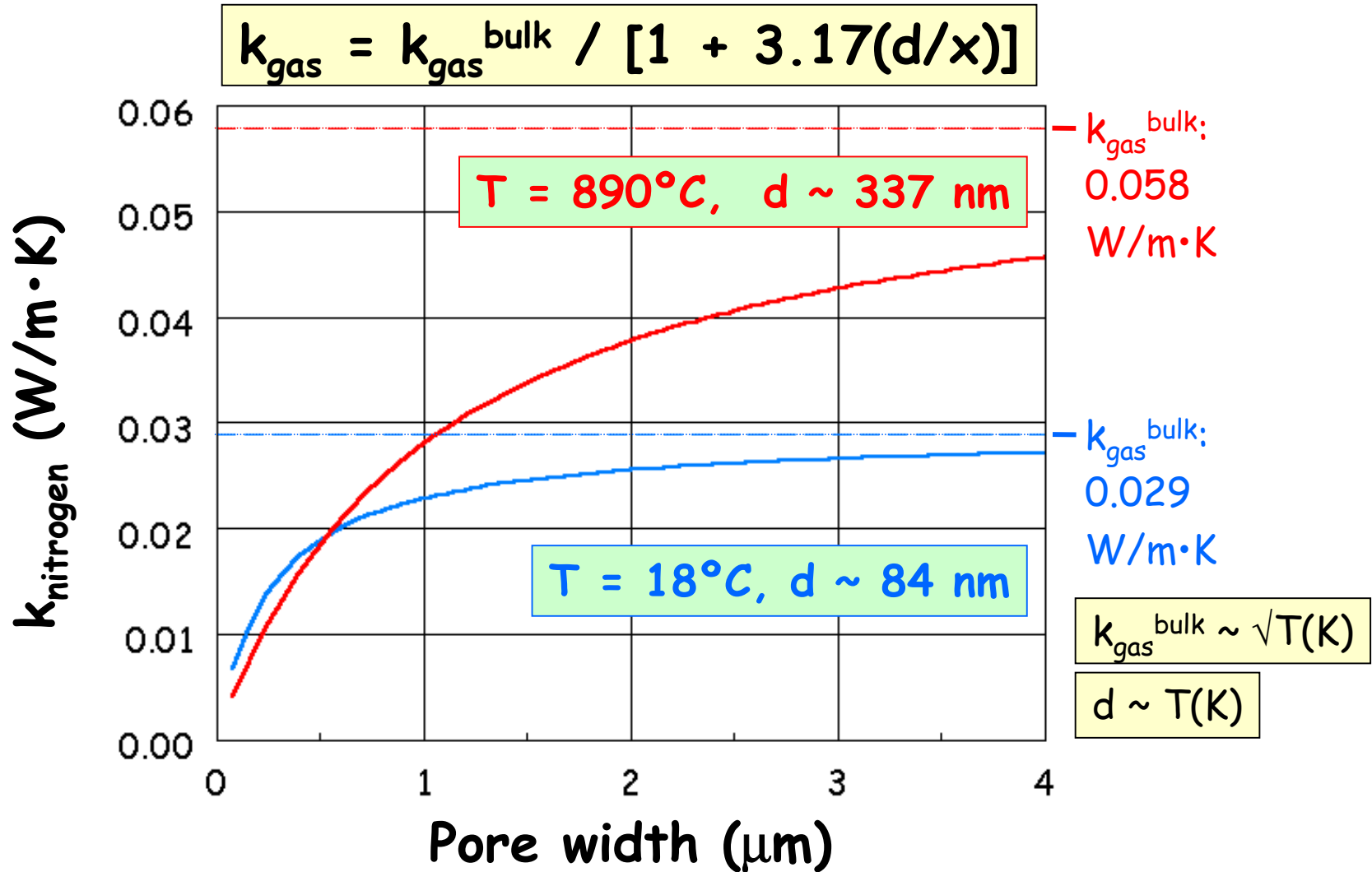


Image Resolution: $0.214 \mu\text{m}/\text{pixel}$

$64.2 \mu\text{m} \times 32.1 \mu\text{m}$

Influences of Feature Size



A. Mogro-Campero, C. A. Johnson, P. J. Bednarczyk, R. B. Dinwiddie, H. Wang, Surf. & Coat. Tech., **94-95**, 102-105 (1997).

Predicting Thermal Properties From Microstructures

SUMMARY:

- **Microstructure-based, finite-element simulations provide a new paradigm for property measurements of complex materials, such as, TBC's.**
- **Sample preparation & image analysis are critical for obtaining accurate, quantitative measures of behavior.**
- **Dimensions of microstructural feature can have significant influences on determined properties.**
- **Finite-element simulations help to elucidate the influences of stochastic microstructural features (e.g., porosity) on the thermal conductivity of complex TBC microstructures.**

Abstract

PREDICTING THERMAL PROPERTIES FROM MICROSTRUCTURES

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James Ruud, N. S. Hari, James C. Grande, Antonio Mogro-Campero,
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Point-to-point knowledge of the thermal properties of thermal barrier coatings (TBC's) is crucial in the design of advanced turbine airfoils to allow more precise component temperature evaluation and more reliable life assessment. However, laser flash measurements for determining thermal diffusivity are generally time consuming and expensive, and require special expertise. An alternate stratagem is to develop finite-element schemes for calculating thermal properties directly from coating microstructures. Such a computational tool, called OOF for Object Oriented Finite element analysis, is used to determine thermal conductivity of TBC's. Simulations are performed for thermal-spray (TS), electron-beam physical vapor deposition (EB-PVD), and electron-beam directed vapor deposition (EB-DVD) microstructures. Laser flash measurements of thermal diffusivity are used to validate the microstructural simulations for a range of thermal-spray microstructures. This validation procedure has indicated many aspects of the image analysis and thermal conductivity physics that must be considered for elucidating the influence of fine microstructural features, such as microcracks.